

High Luminous Efficacy  
Green LED Emitter  
**LZ1-00G105**



## Key Features

- High Luminous Efficacy 5W Green LED
- Ultra-small foot print – 4.4mm x 4.4mm x 3.2mm
- Surface mount ceramic package with integrated glass lens
- Very low Thermal Resistance (5.5°C/W)
- Very high Luminous Flux density
- New industry standard for Lumen Maintenance (>90% at 100,000 Hours)
- Autoclave complaint (JEDEC JESD22-A102-C)
- JEDEC Level 1 for Moisture Sensitivity Level
- Lead (Pb) free and RoHS compliant
- Reflow solderable (up to 6 cycles)
- Emitter available on [Standard](#) or [Miniature](#) MCPCB (optional)

## Typical Applications

- Indoor and outdoor Architectural Lighting
- Display Backlighting
- Full Color Displays
- Projectors

## Description

The LZ1-00G105 Green LED emitter provides 5W power in an extremely small package. With a 4.4mm x 4.4mm x 3.2mm ultra-small footprint, this package provides exceptional luminous flux density. The patent-pending design has unparalleled thermal and optical performance and excellent UV resistance. The high quality materials used in the package are chosen to optimize light output and minimize stresses which results in monumental reliability and lumen maintenance. The robust product design thrives in outdoor applications with high ambient temperatures and high humidity.

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## Product Nomenclature

The LZ Series part number designation is defined as follows:



Where:

- A – designates the number of LED die in the package (“1” for 5W)
- B – designates the package level (“0” for Emitter)
- C – designates the radiation pattern (“0” for Lambertian)
- D and E – designate the color (“G1” for Green – 523nm Dominant Wavelength)
- F and G – designate the Power (“05” for 5W typical rating)
- H – designates the Flux bin (See Table 2)
- J and K – designate the Dominant Wavelength bin (see Table 3)
- L – designates the  $V_F$  bin (See Table 4)

Ordering information:

For ordering LedEngin products, please reference the base part number. The base part number represents any of the flux, dominant wavelength, or forward voltage bins specified in the binning tables below. For ordering products with special bin selections, please contact a LedEngin sales representative or authorized distributor.

## IPC/JEDEC Moisture Sensitivity Level

Table 1 - IPC/JEDEC J-STD-20D.1 MSL Classification:

Level	Soak Requirements					
	Floor Life		Standard		Accelerated	
	Time	Conditions	Time (hrs)	Conditions	Time (hrs)	Conditions
1	Unlimited	≤ 30°C/ 85% RH	168 +5/-0	85°C/ 85% RH	n/a	n/a

Notes for Table 1:

1. The standard soak time includes a default value of 24 hours for semiconductor manufacturer’s exposure time (MET) between bake and bag and includes the maximum time allowed out of the bag at the distributor’s facility.

## Average Lumen Maintenance Projections

Lumen maintenance generally describes the ability of a lamp to retain its output over time. The useful lifetime for solid state lighting devices (Power LEDs) is also defined as Lumen Maintenance, with the percentage of the original light output remaining at a defined time period.

Based on long-term WHTOL testing, LedEngin projects that the LZ Series will deliver, on average, 90% Lumen Maintenance at 100,000 hours of operation at a forward current of 1000 mA. This projection is based on constant current operation with junction temperature maintained at or below 125°C.

## Luminous Flux Bins

Table 2:

Bin Code	Minimum Luminous Flux ( $\Phi_V$ ) @ $I_F = 1000\text{mA}$ <sup>[1,2,3]</sup> (lm)	Maximum Luminous Flux ( $\Phi_V$ ) @ $I_F = 1000\text{mA}$ <sup>[1,2,3]</sup> (lm)	Typical Luminous Flux ( $\Phi_V$ ) @ $I_F = 1500\text{mA}$ <sup>[3]</sup> (lm)
M	116	145	170
N	145	182	205
P	182	228	255

Notes for Table 2:

1. Luminous flux performance guaranteed within published operating conditions.
2. LedEngin maintains a tolerance of  $\pm 10\%$  on flux measurements.
3. Future products will have even higher levels of luminous flux performance. Contact LedEngin Sales for updated information.

## Dominant Wavelength Bins

Table 3:

Bin Code	Minimum Dominant Wavelength ( $\lambda_D$ ) @ $I_F = 700\text{mA}$ <sup>[1,2]</sup> (nm)	Maximum Dominant Wavelength ( $\lambda_D$ ) @ $I_F = 700\text{mA}$ <sup>[1,2]</sup> (nm)
G2	520	525
G3	525	530
G4	530	535

Notes for Table 3:

1. Dominant wavelength is derived from the CIE 1931 Chromaticity Diagram and represents the perceived hue.
2. LedEngin maintains a tolerance of  $\pm 0.5\text{nm}$  on dominant wavelength measurements.

## Forward Voltage Bins

Table 4:

Bin Code	Minimum Forward Voltage ( $V_F$ ) @ $I_F = 1000\text{mA}$ <sup>[1]</sup> (V)	Maximum Forward Voltage ( $V_F$ ) @ $I_F = 1000\text{mA}$ <sup>[1]</sup> (V)
J	3.92	4.16
K	4.16	4.40
L	4.40	4.64
M	4.64	4.88
N	4.88	5.12
P	5.12	5.36

Notes for Table 4:

1. LedEngin maintains a tolerance of  $\pm 0.04\text{V}$  for forward voltage measurements.

## Absolute Maximum Ratings

Table 5:

Parameter	Symbol	Value	Unit
DC Forward Current <sup>[1]</sup>	$I_F$	1500	mA
Peak Pulsed Forward Current <sup>[2]</sup>	$I_{FP}$	2000	mA
Reverse Voltage	$V_R$	See Note 3	V
Storage Temperature	$T_{stg}$	-40 ~ +150	°C
Junction Temperature	$T_J$	150	°C
Soldering Temperature <sup>[4]</sup>	$T_{sol}$	260	°C
Allowable Reflow Cycles		6	
Autoclave Conditions <sup>[5]</sup>		121°C at 2 ATM, 100% RH for 168 hours	
ESD Sensitivity <sup>[6]</sup>		> 1,000 V HBM Class 1C JESD22-A114-D	

Notes for Table 5:

- Maximum DC forward current is determined by the overall thermal resistance and ambient temperature. Follow the curves in Figure 11 for current derating.
- Pulse forward current conditions: Pulse Width  $\leq$  10msec and Duty cycle  $\leq$  10%.
- LEDs are not designed to be reverse biased.
- Solder conditions per JEDEC 020c. See Reflow Soldering Profile Figure 3.
- Autoclave Conditions per JEDEC JESD22-A102-C.
- LedEngin recommends taking reasonable precautions towards possible ESD damages and handling the LZ1-00G105 in an electrostatic protected area (EPA). An EPA may be adequately protected by ESD controls as outlined in ANSI/ESD S6.1.

## Optical Characteristics @ $T_C = 25^\circ\text{C}$

Table 6:

Parameter	Symbol	Typical	Unit
Luminous Flux (@ $I_F = 1000\text{mA}$ )	$\Phi_V$	165	lm
Luminous Flux (@ $I_F = 1500\text{mA}$ )	$\Phi_V$	205	lm
Dominant Wavelength (@ $I_F = 700\text{mA}$ )	$\lambda_D$	523	nm
Viewing Angle <sup>[1]</sup>	$2\Theta_{1/2}$	80	Degrees
Total Included Angle <sup>[2]</sup>	$\Theta_{0.9}$	90	Degrees

Notes for Table 6:

- Viewing Angle is the off axis angle from emitter centerline where the luminous intensity is  $\frac{1}{2}$  of the peak value.
- Total Included Angle is the total angle that includes 90% of the total luminous flux.

## Electrical Characteristics @ $T_C = 25^\circ\text{C}$

Table 7:

Parameter	Symbol	Typical	Unit
Forward Voltage (@ $I_F = 1000\text{mA}$ )	$V_F$	4.5	V
Forward Voltage (@ $I_F = 1500\text{mA}$ )	$V_F$	5.0	V
Temperature Coefficient of Forward Voltage	$\Delta V_F / \Delta T_J$	-4.0	mV/°C
Thermal Resistance (Junction to Case)	$R\Theta_{J-C}$	5.5	°C/W

## Mechanical Dimensions (mm)

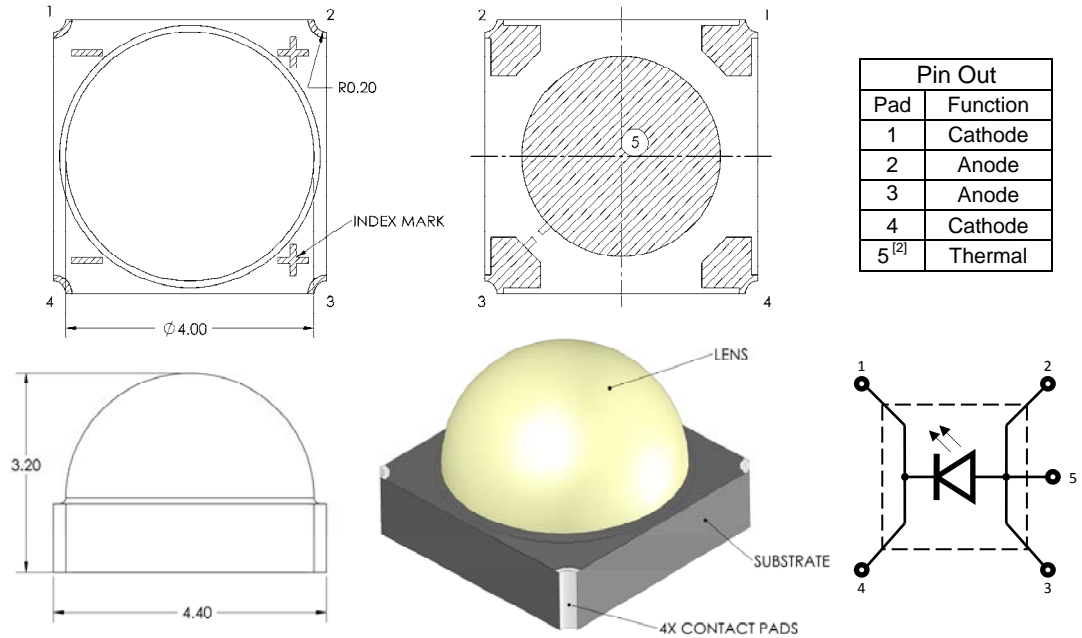


Figure 1: Package outline drawing.

### Notes for Figure 1:

1. Unless otherwise noted, the tolerance =  $\pm 0.20$  mm.
2. Thermal contact, Pad 5, is electrically connected to the Anode, Pads 2 and 3. Do not connect any pad to the thermal contact, Pad # 5. When mounting the LZ1-00G105 onto a MCPCB, by default its dielectric layer provides for the necessary electrical insulation in between all contact pads. LedEngin offers [LZ1-10G105](#) and [LZ1-30G105](#) MCPCB options which provide for electrical insulation between all contact pads. Please refer to Application Note MCPCB Option 1 and Option 3, or contact a LedEngin sales representative for more information.

## Recommended Solder Pad Layout (mm)

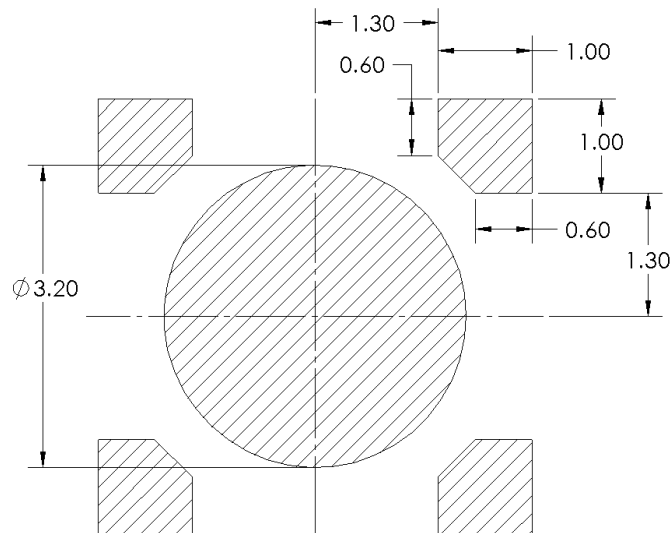


Figure 2: Recommended solder mask opening (hatched area) for anode, cathode, and thermal pad.

### Note for Figure 2:

1. Unless otherwise noted, the tolerance =  $\pm 0.20$  mm.

## Reflow Soldering Profile

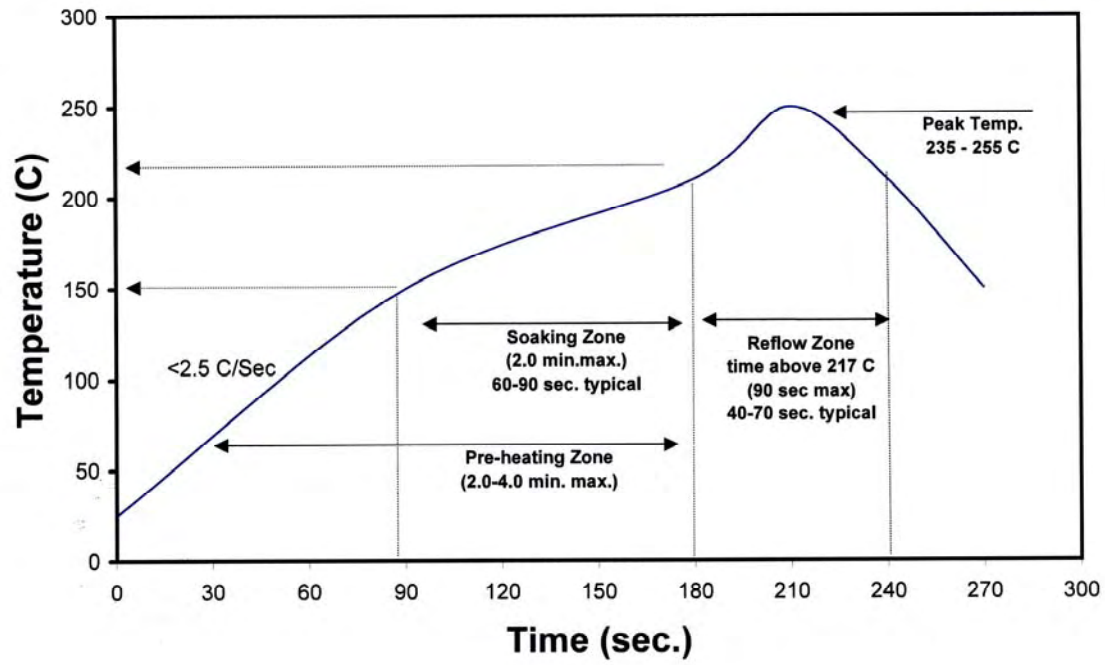


Figure 3: Reflow soldering profile for lead free soldering.

## Typical Radiation Pattern

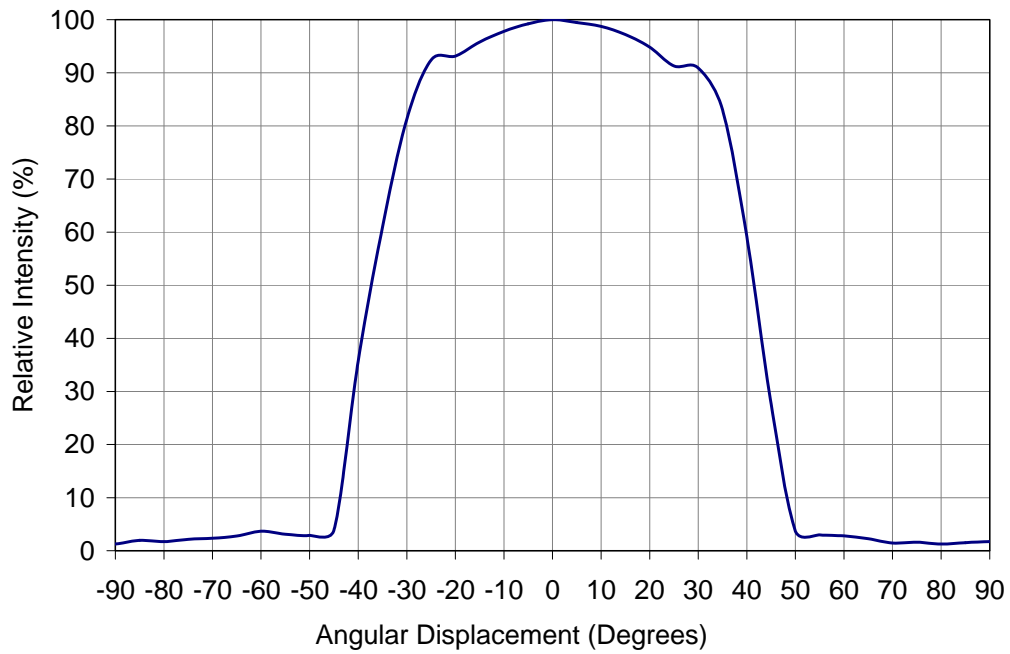


Figure 4: Typical representative spatial radiation pattern @  $T_C = 25^\circ\text{C}$ .

## Typical Relative Spectral Power Distribution

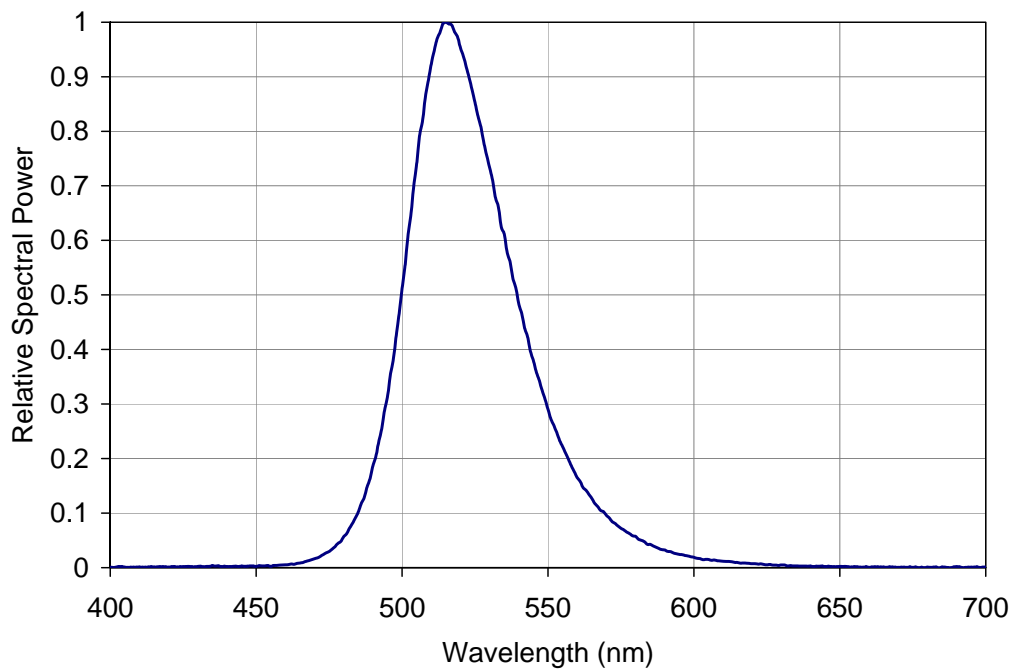


Figure 5: Relative spectral power vs. wavelength @  $I_F = 350\text{mA}$  and  $T_C = 25^\circ\text{C}$ .



## Typical Relative Dominant Wavelength Shift

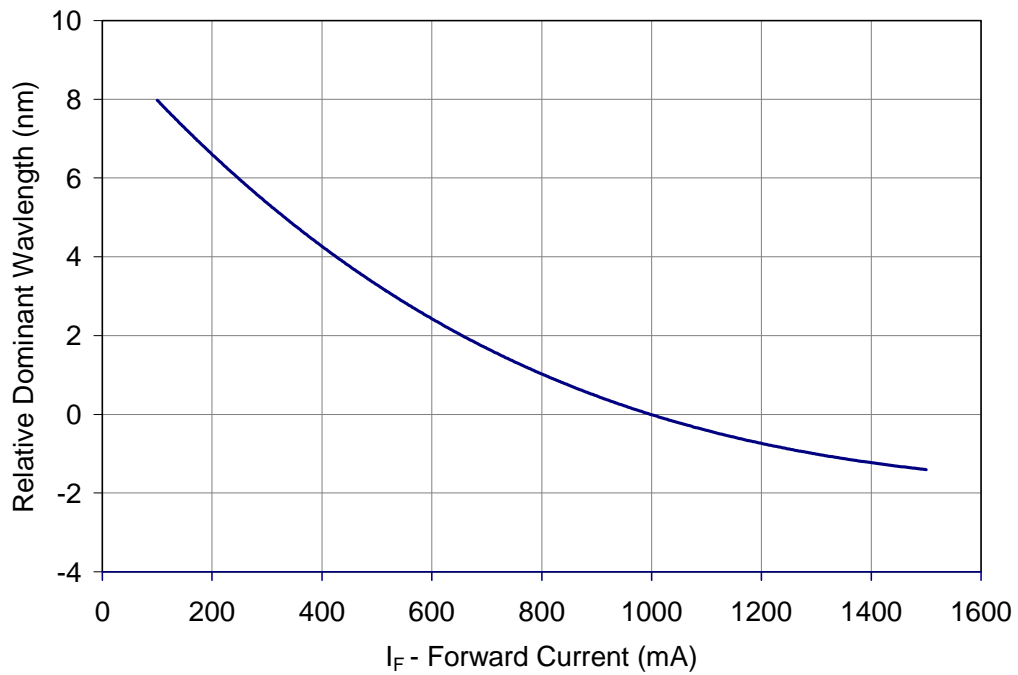


Figure 6: Typical dominant wavelength shift vs. forward current @ T<sub>C</sub> = 25°C.

## Typical Relative Dominant Wavelength Shift over Temperature

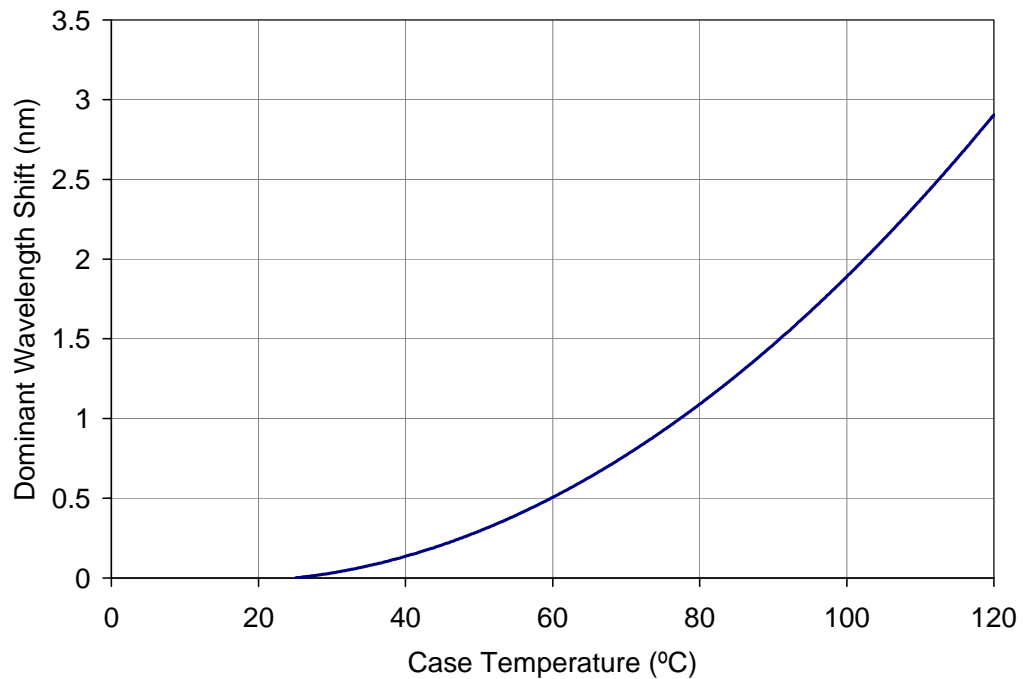


Figure 7: Typical dominant wavelength shift vs. case temperature.

## Typical Relative Light Output

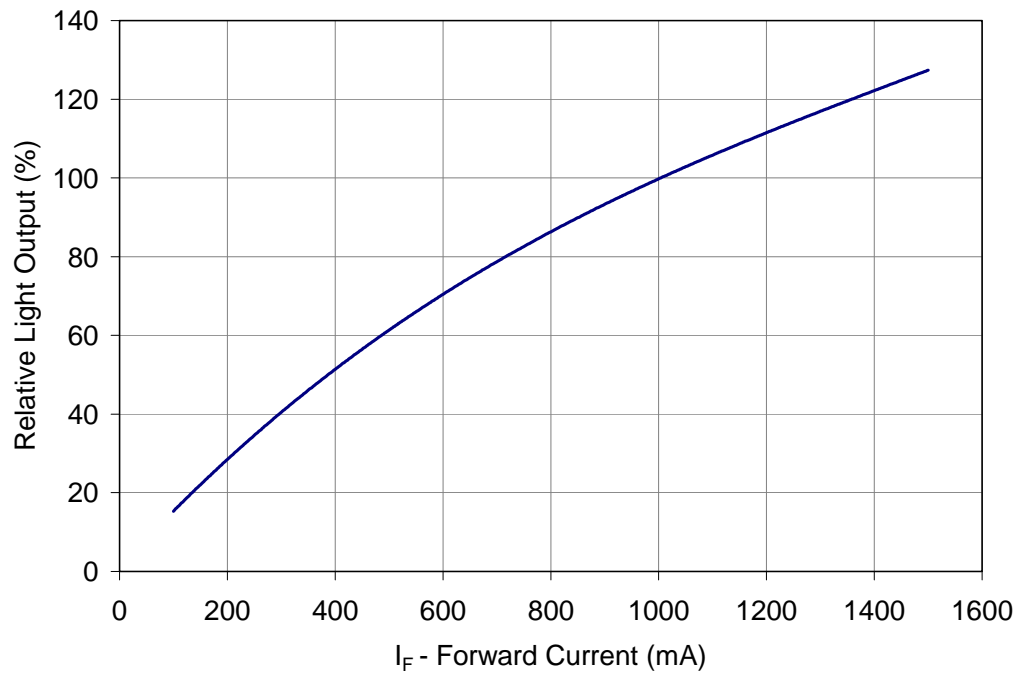


Figure 8: Typical relative light output vs. forward current @ T<sub>C</sub> = 25°C.

## Typical Relative Light Output over Temperature

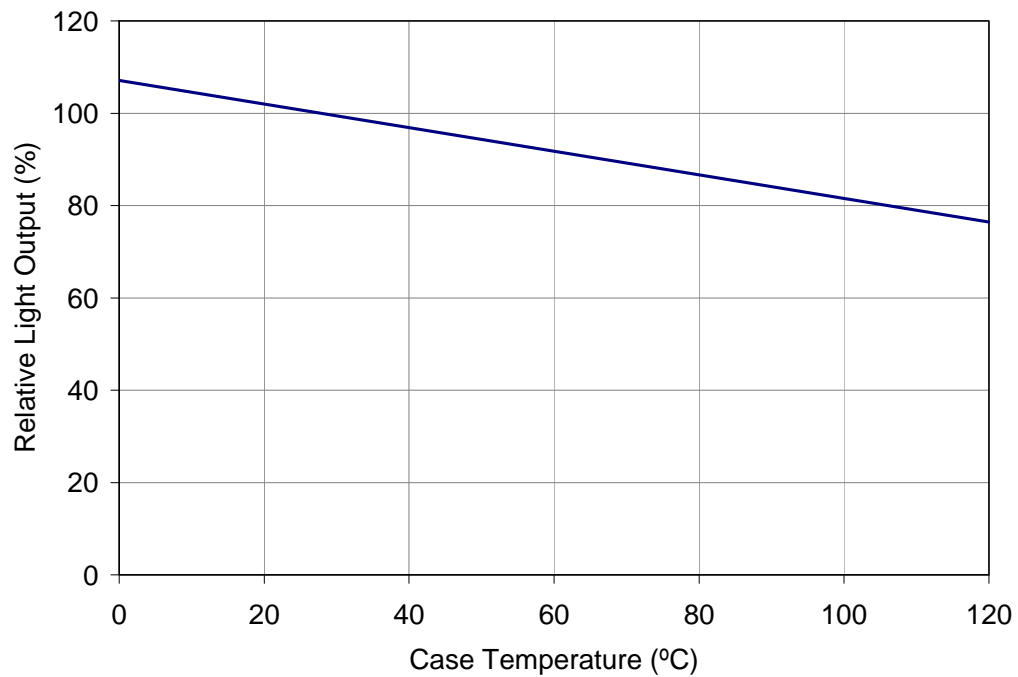


Figure 9: Typical relative light output vs. case temperature.

## Typical Forward Current Characteristics

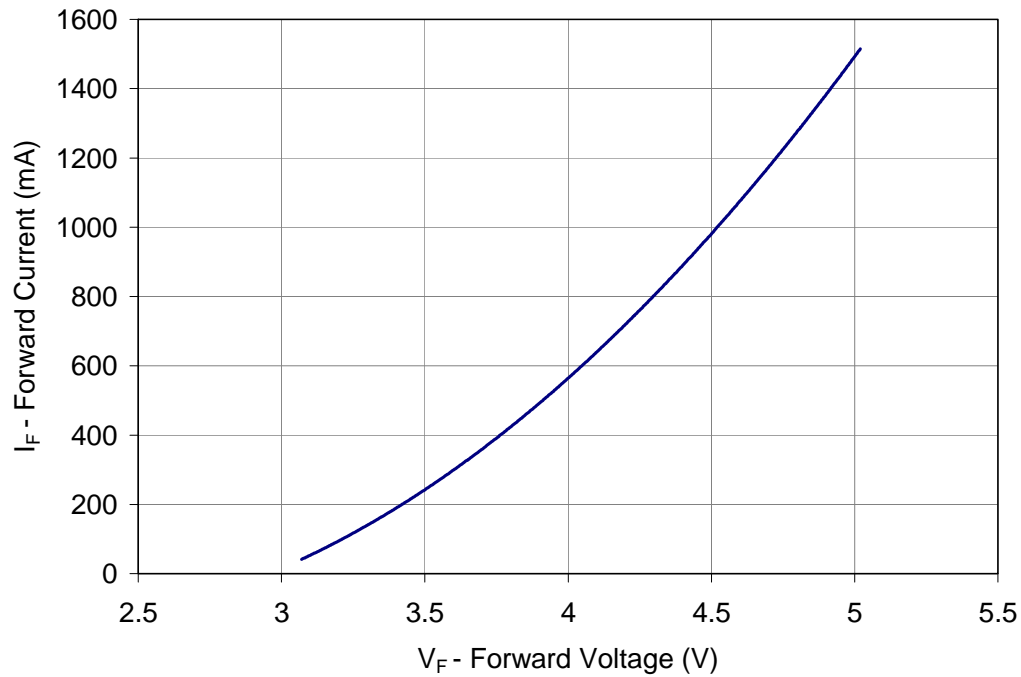


Figure 10: Typical forward current vs. forward voltage @  $T_C = 25^\circ\text{C}$ .

## Current Derating

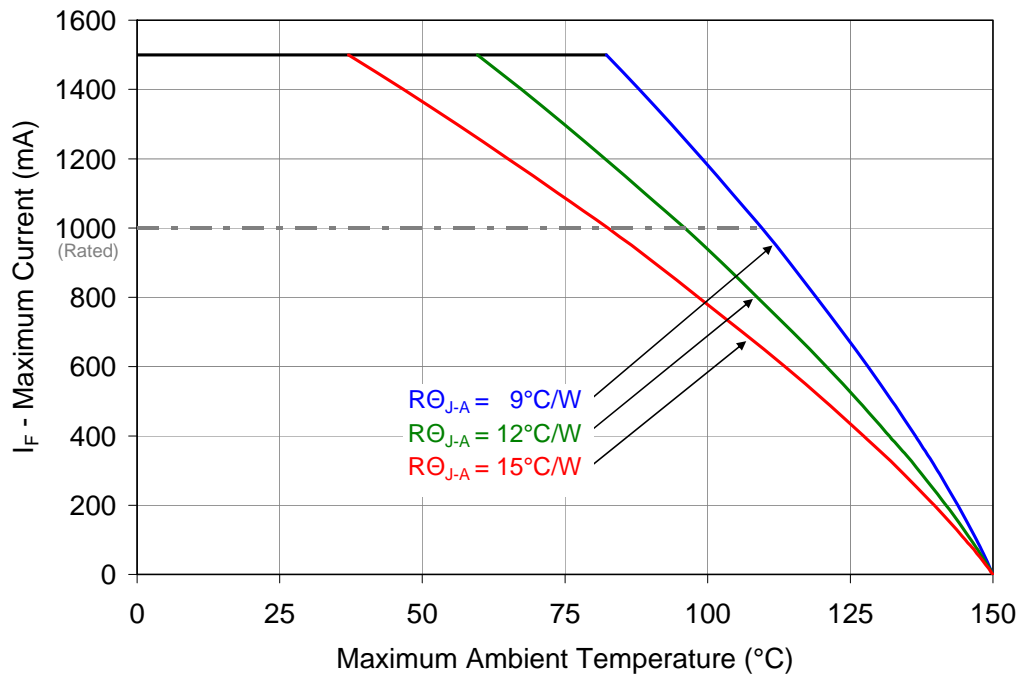


Figure 11: Maximum forward current vs. ambient temperature based on  $T_{J(\text{MAX})} = 150^\circ\text{C}$ .

Notes for Figure 11:

1.  $R\theta_{J-C}$  [Junction to Case Thermal Resistance] for the LZ1-00G105 is typically  $5.5^\circ\text{C/W}$ .
2.  $R\theta_{J-A}$  [Junction to Ambient Thermal Resistance] =  $R\theta_{J-C}$  +  $R\theta_{C-A}$  [Case to Ambient Thermal Resistance].

## Emitter Tape and Reel Specifications (mm)

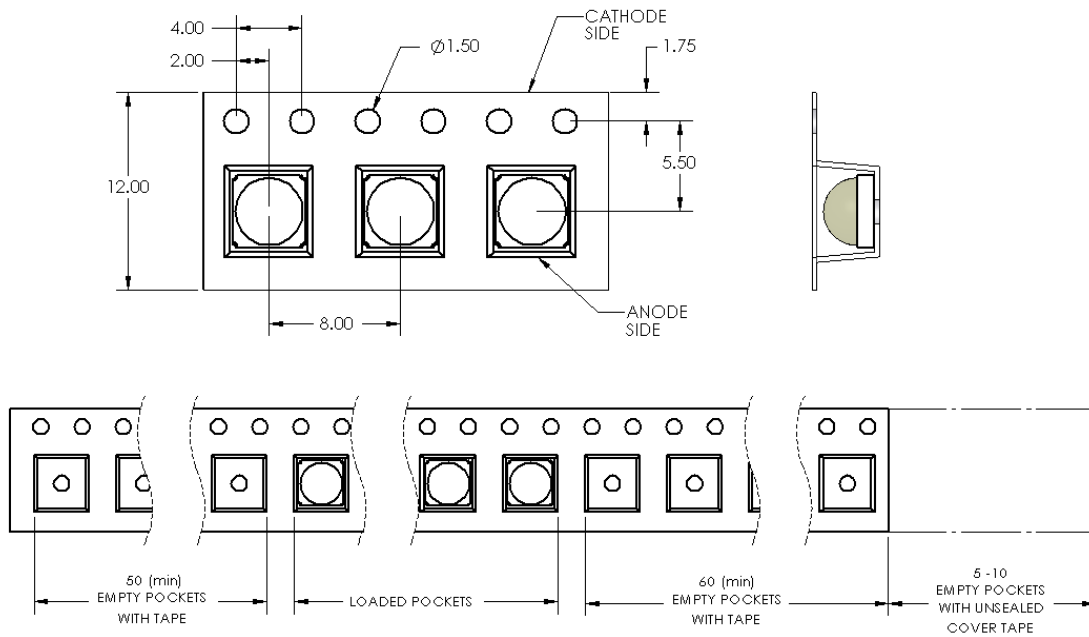


Figure 12: Emitter carrier tape specifications (mm).

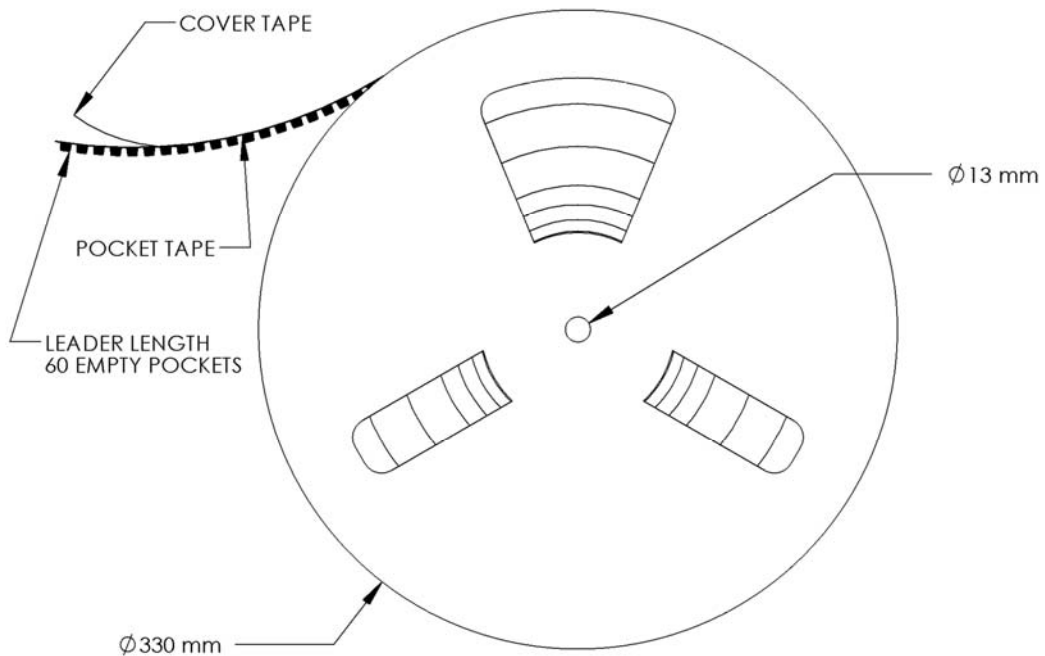


Figure 13: Emitter reel specifications (mm).

## Company Information

LedEngin, Inc. is a Silicon Valley based solid-state lighting company specializing in the development and manufacturing of unprecedented high-power LED emitters, modules and replacement lamps. LedEngin's packaging technologies lead the industry with products that feature lowest thermal resistance, highest flux density and consummate reliability, enabling compact and efficient solid state lighting solutions.

LedEngin's LED emitters range from 3W to 40W with ultra-compact footprints and are available in single color products including Cool White, Neutral White, Warm White, Red, Green, Blue, Amber, Deep Red, Far Red, Dental Blue and UV as well as multi-color products with RGB, RGBA and RGBW options. LedEngin's brightest White LEDs are capable of emitting 2,000 lumens.

LedEngin's robust emitters are at the core of its unique line of modules and replacement lamps producing unmatched beam quality resulting in true Lux on Target™ for a wide variety of spot and narrow flood directional lighting applications.

LedEngin is committed to providing products that conserve natural resources and reduce greenhouse emissions.

LedEngin reserves the right to make changes to improve performance without notice.

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